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REQUEST  
FOR  
CONTINUED EXAMINATION (RCE)  
TRANSMITTAL

MAIL STOP RCE

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Subsection (b) of 35 U.S.C. § 132, effective on May 29, 2000,  
provides for continued examination of an utility or  
plant application filed on or after June 8, 1995

Application Number	10/765,220
Confirmation Number	7643
Filing Date	January 28, 2004
First Named Inventor	Yoshihiko UCHIDA
Group Art Unit	2818
Examiner Name	Andy Huynh
Matter Number	Q79569
Title	ORGANIC SEMICONDUCTOR ELEMENT HAVING HIGH INSULATION STRENGTH AND FABRICATION METHOD THEREOF

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the above-identified application.

1. SUBMISSION REQUIRED UNDER 37 C.F.R. § 1.114

- a. ☐ Previously submitted
- i. ☐ Please enter and consider the amendment(s)/reply under 37 C.F.R. § 1.116  
previously filed on \_\_\_\_\_
- ii. ☐ Consider the arguments in the Appeal Brief or Reply Brief previously filed on \_\_\_\_\_
- iii. ☐ Other \_\_\_\_\_
- b. ☒ Enclosed
- i. ☒ Amendment/Reply
- ii. ☐ Affidavit(s)/Declaration(s)
- iii. ☐ Information Disclosure Statements (IDS)
- iv. ☒ Petition for Extension of Time
- v. ☐ Other \_\_\_\_\_

2. MISCELLANEOUS

- a. ☐ Suspension of action on the above-identified application is requested under 37 C.F.R. § 1.103(c) for a  
period of \_\_\_\_\_ months
- b. ☐ Other \_\_\_\_\_

3. FEES

A check for the RCE statutory fee of \$790.00 is attached. The USPTO is directed and authorized to charge all  
required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any  
overpayments to said Deposit Account. A duplicate copy of this transmittal letter is attached.

CORRESPONDENCE ADDRESS

Direct all correspondence to the address for SUGHRUE MION, PLLC filed under the Customer Number listed below:

WASHINGTON OFFICE

23373

CUSTOMER NUMBER

02/28/2006 JADD01 00000013 10765220

01 FC:1801

790.00 OP

SIGNATURE OF ATTORNEY

Name Abraham J. Rosner Registration No. 33,276

Signature *[Signature]* Date February 27, 2006